Power MOSFET 60 V, 6.5 m Ω , 70 A, Single N–Channel

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

WAXIMUW RATING5	$(1_{\rm J} = 25^{\circ})$	unless other	vise noted)			
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	70	А	
Current R _{θJC} (Notes 1, 2, 3, 4)		T _C = 100°C		49		
Power Dissipation		T _C = 25°C	PD	63	W	
$R_{\theta JC}$ (Notes 1, 2, 3)		$T_{C} = 100^{\circ}C$		31		
Continuous Drain	Steady State	T _A = 25°C	۱ _D	16	А	
Current R _{0JA} (Notes 1 & 3, 4)		T _A = 100°C		11		
Power Dissipation		T _A = 25°C	PD	3.2	W	
R _{θJA} (Notes 1, 3)		$T_A = 100^{\circ}C$		1.6		
Pulsed Drain Current	$T_{A} = 25$	°C, t _p = 10 μs	I _{DM}	440	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	68	А	
Single Pulse Drain–to–Source Avalanche Energy ($I_{L(pk)} = 3.6 \text{ A}$)			E _{AS}	166	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

MAXIMUM RATINGS (T = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 3)	$R_{\theta JC}$	2.4	°C/W
Junction-to-Ambient - Steady State (Note 3)	R_{\thetaJA}	47]

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface. 3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

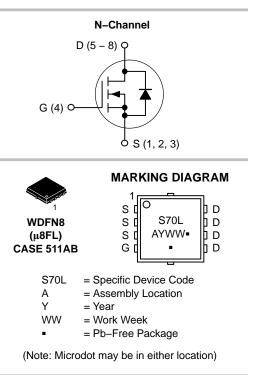
- 4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	6.5 mΩ @ 10 V	70 A
60 V	9.1 mΩ @ 4.5 V	101



ORDERING INFORMATION

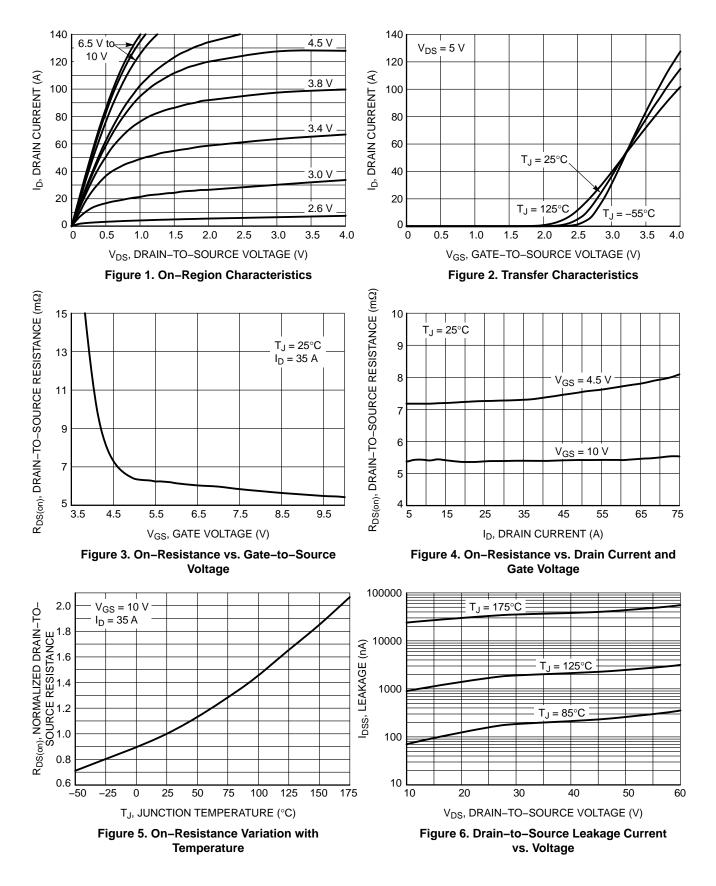
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

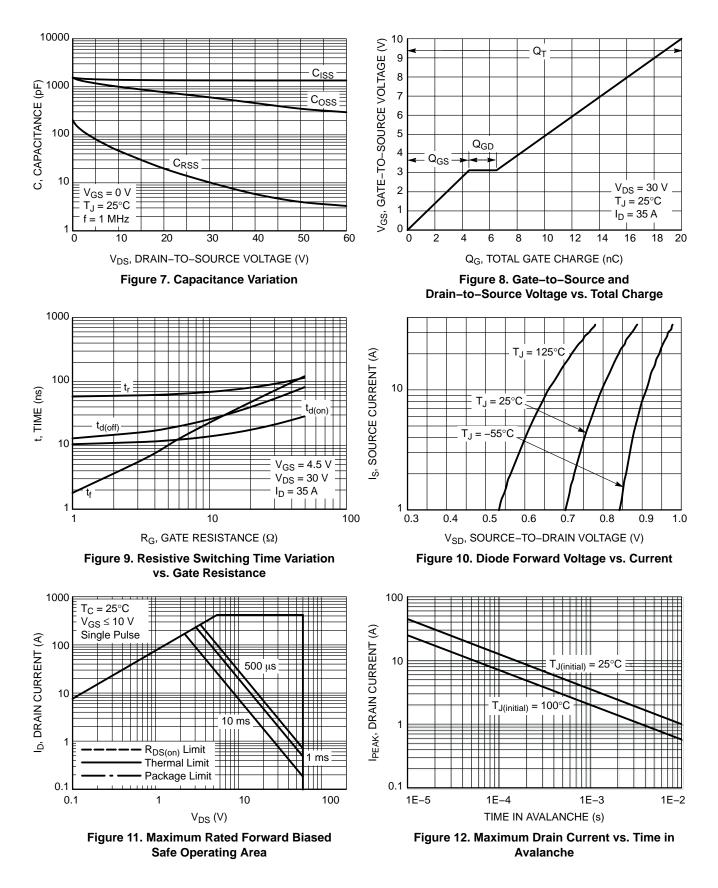
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				27		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$			10 250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	ů			100	nA
ON CHARACTERISTICS (Note 5)	000		0 -				
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 50 μA		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	νως – νως, ημη συ μη			-4.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A		5.4	6.5	
		V _{GS} = 4.5 V	I _D = 35 A		7.3	9.1	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 35 A			82		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1400		pF
Output Capacitance	C _{OSS}				690		
Reverse Transfer Capacitance	C _{RSS}				15		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 35 A			9.0		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 30 V; I _D = 35 A			20		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 35 A			2.5		nC V
Gate-to-Source Charge	Q _{GS}				4.5		
Gate-to-Drain Charge	Q _{GD}				2.0		
Plateau Voltage	V _{GP}				3.1		
SWITCHING CHARACTERISTICS (Note e	6)				•		
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 30 V, I _D = 35 A, R _G = 2.5 Ω			11		ns
Rise Time	tr				60		
Turn–Off Delay Time	t _{d(OFF)}				15		
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						-
Forward Diode Voltage	V _{SD}	$v_{GS} = 0 v$,	$T_J = 25^{\circ}C$		0.9	1.2	
			T _J = 125°C		0.8		V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 35 A			34		
Charge Time	t _a				17		ns
Discharge Time	t _b				17		
Reverse Recovery Charge	Q _{RR}				19		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



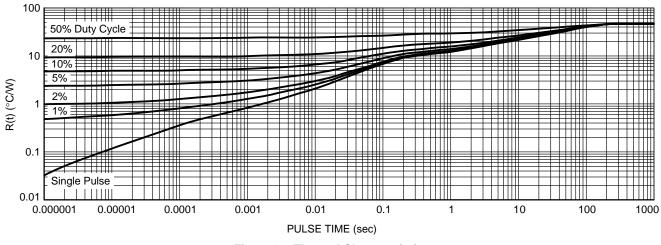


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTTFS5CS70NLTAG	S70L	WDFN8 (Pb–Free)	1500 / Tape & Reel
NTTFS5CS70NLTWG	S70L	WDFN8 (Pb–Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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